## DATA SHEET

■ DEVICE NUMBER: HL-M1388BR

(For: )

SHEET	1	2	3	4	5	6	7		CONTENTS
2011.12.24	1.0	1.0	1.0	1.0	1.0				Original Released

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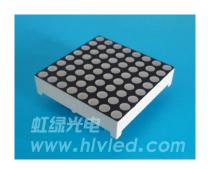
Http://www.hlvled.com

•	APPROVED	DRAWER
	罗 2011. 12. 24	王 2011. 12. 24
	世年	小燕



### **■** Features:

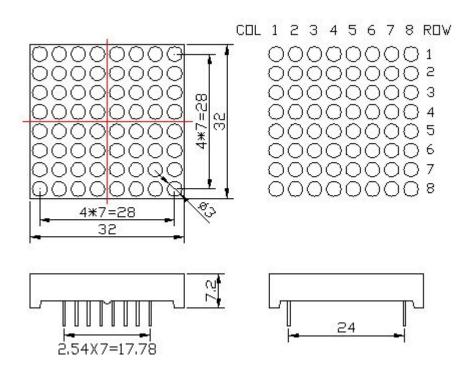
- 1. 8×8 dot matrix display.
- 2. Dot Size: 3.0mm.
- 3. Low power consumption.
- 4. Lens Color: black face and white segments..
- 5. Categorized for luminous intensity.
- 6. RoHS compliant



### ■ Device Selection Guide :

MadalNa	Description	Chip			
Model No.	Description	Material	Emitting Color		
HL-M1388BR	Common Anode	AlGaInP	Super Orange Red		

### ■ Mechanical Dimensions:



### Notes:

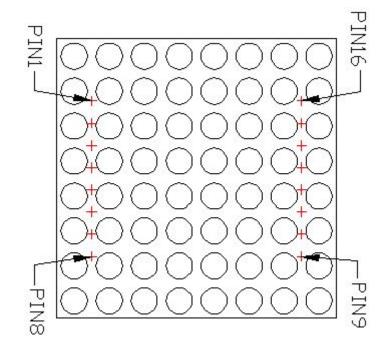
- 1.All dimensions are in millimeters(inches).
- 2. Tolerance is  $\pm 0.25$ mm(.01")unless otherwise specified.
- 3. Specifications are subject to change without notice.

Model No: HL-M1388BR Ver.1.0 Page 1 of 5

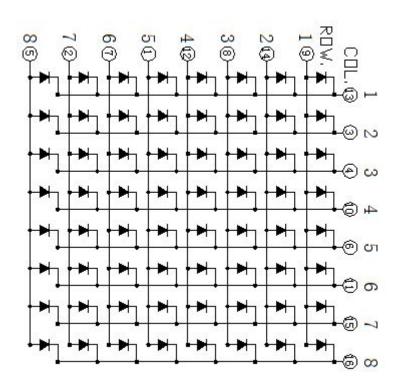


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# All Light On Segments Feature & Pin Position:



# ■ Internal Circuit Diagrams:



Model No: HL-M1388BR Ver.1.0 Page 2 of 5

### ■ Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit
Pulse Forward Current*1	Pd	60	mW
Forward Current	l <sub>F</sub>	30	mA
Peak Forward Current	I <sub>FP</sub>	80	mA
Reverse Volage	V <sub>R</sub>	5	V
Operating Temperature	Topr	-40~ +105	$^{\circ}\!$
Storage Temperature	Tstg	-40~ +105	$^{\circ}$
Reflow Temperature*2	Tsol	260	$^{\circ}\!\mathbb{C}$
Electrostatic Discharge	ESD	2000	V

### Note:

### ■ Electrical and optical characteristics (Ta=25°C)

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Forward Voltage	Vf	I <sub>F</sub> =20mA	-	2.0	2.5	V
Luminous Intensity/segment	Iv	I <sub>F</sub> =10mA	-	35	-	mcd
Reverse Current	$I_R$	V <sub>R</sub> =5V	-	-	100	μΑ
Peak Wave Length	λр	I <sub>F</sub> =20mA		630		nm
Dominant Wave Length	λd	I <sub>F</sub> =20mA	620	-	630	nm
Spectral Line Half-width	Δλ	I <sub>F</sub> =20mA	-	20	-	nm

Model No: HL-M1388BR Ver.1.0 Page 3 of 5

<sup>\*1:</sup> IFp Conditions :Pulse Width ≤10msec.and Duty cycle≤1/10.

<sup>\*2:</sup> Reflow time≤5 seconds.



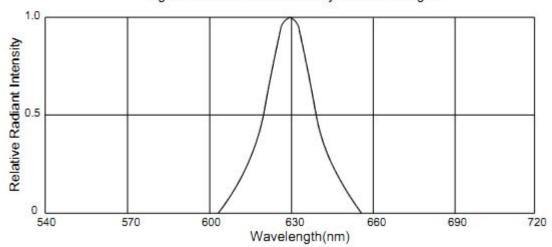
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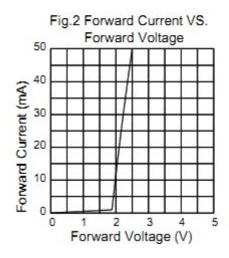
### SHENZHEN HLVLED OPTOELECTRONIC CO., LTD.

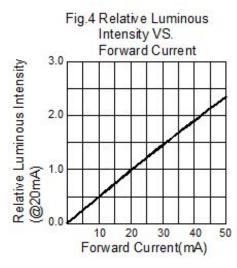
### **■** Typical Electro-Optical Characteristics Curves

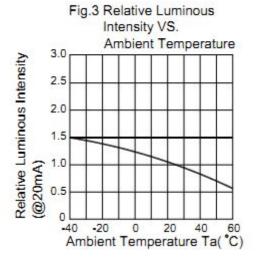
(25℃ Ambient Temperature Unless Otherwise Noted)

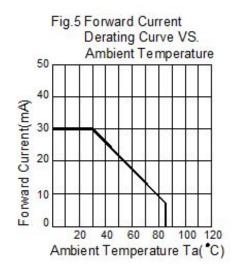
Fig.1 Relative Radiant Intensity VS. Wavelength











Model No: HL-M1388BR Ver.1.0 Page 4 of 5



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### ■ Reliability test items:

No.	Test Item	Test Condition	Time/Cycle	Judgment Criteria	Number Damaged
1	Reflow Soldering	TEMP: 260°C±5°C  MAX: 5sec	6 Min		0/30
2	Thermal shock	H: +100°C 5min L: -40°C 5min	300 Cycles	lv≤Ivt*0.5 Vf≥U	0/30
3	High temp storage	100℃	1000 Hrs	V1≥0 Vf≤L	0/30
4	Low temp storage	-40℃	1000 Hrs		0/30
5	Temperature cycle	H: +100°C 15min L: -40°C 15min	300 Cycles		0/30
6	High temp high humidity	85℃,85%RH	1000 Hrs		0/30

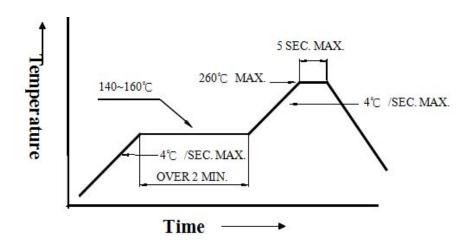
Note: Ivt: The test Iv value of the chip before the reliability test.

IV: The test value of the chip that has completed the reliability test.

U: Upper Specification Limit.

L: Lower Specification Limit.

### ■ IR Reflow temperature/Time:



### ■ Soldering Iron:

Ferrochromium soldering:power keep no more than 40W,tip temperature should not pass  $260^{\circ}$ C,soldering Time Within 3 second.

Model No: HL-M1388BR Ver.1.0 Page 5 of 5